

### **General Description**

The MAX703/MAX704 microprocessor (µP) supervisory circuits reduce the complexity and number of components required for power-supply monitoring and battery control functions in µP systems. These devices significantly improve system reliability and accuracy compared to that obtained with separate ICs or discrete components.

The MAX703/MAX704 are available in 8-pin DIP and SO packages and provide four functions:

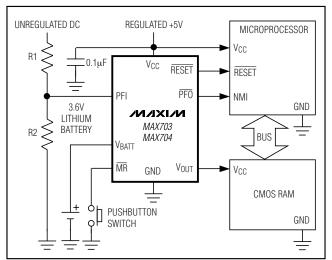
- 1) An active-low reset during power-up, power-down, and brownout conditions.
- 2) Battery-backup switching for CMOS RAM, CMOS uPs, or other low-power logic circuitry.
- 3) A 1.25V threshold detector for power-fail warning, low-battery detection, or for monitoring a power supply other than +5V.
- 4) An active-low manual reset input.

The MAX703 and MAX704 differ only in their supplyvoltage monitor levels. The MAX703 generates a reset when the supply drops below 4.65V, while the MAX704 generates a reset below 4.4V.

### **Applications**

Computers Controllers Intelligent Instruments **Automotive Systems** Critical uP Power Monitoring

### Typical Operating Circuit



### **Features**

- Battery-Backup Power Switching
- Precision Supply-Voltage Monitor 4.65V (MAX703) 4.40V (MAX704)
- ♦ 200ms Reset Pulse Width
- **♦** Debounced TTL/CMOS-Compatible Manual Reset Input
- ♦ 200µA Quiescent Current
- ◆ 50nA Quiescent Current in Battery-Backup Mode
- **Voltage Monitor for Power-Fail or Low-Battery** Warning
- 8-Pin DIP and SO Packages
- ♦ Guaranteed RESET Assertion to V<sub>CC</sub> = 1V

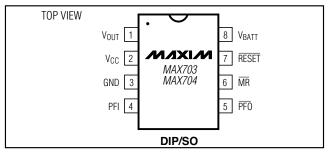
### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX703C/D	0°C to +70°C	Dice*
MAX703CPA	0°C to +70°C	8 PDIP
MAX703CSA	0°C to +70°C	8 SO
MAX703EPA	-40°C to +85°C	8 PDIP
MAX703ESA	-40°C to +85°C	8 SO
MAX703MJA	-55°C to +125°C	8 CERDIP**
MAX704C/D	0°C to +70°C	Dice*
MAX704CPA	0°C to +70°C	8 PDIP
MAX704CSA	0°C to +70°C	8 SO
MAX704EPA	-40°C to +85°C	8 PDIP
MAX704ESA	-40°C to +85°C	8 SO
MAX704MJA	-55°C to +125°C	8 CERDIP**

<sup>\*</sup>Dice are tested at  $T_A = +25$ °C only.

Devices in PDIP and SO packages are available in both leaded and lead-free packaging. Specify lead free by adding the + symbol at the end of the part number when ordering. Lead free not available for CERDIP package.

### Pin Configuration



MIXIM

Maxim Integrated Products 1

<sup>\*\*</sup>Contact factory for availability and processing to MIL-STD-883.

### **ABSOLUTE MAXIMUM RATINGS**

Terminal Voltage (with respect to GND)		Rate-of-Rise VBATT, VCC	100V/µs
VCCVBATTAll Other Inputs (Note 1)	0.3V to +6.0V	Operating Temperature Range C Suffix E Suffix	0°C to +70°C
Input Current VCC	200mA	M Suffix	
VBATT GND		8-Pin PDIP (derated 9.09mW/°C above 8-Pin SO (derated 5.88mW/°C above	
Output Current VOUTShort-Circuit F	Protected for Lln to 10s	8-Pin CERDIP (derated 8.00mW/°C al Storage Temperature Range	,
All Other Outputs		Lead Temperature (soldering, 10s)	

Note 1: V<sub>CB</sub> is the greater of V<sub>CC</sub> and V<sub>BATT</sub>. The input voltage limits on PFI and MR may be exceeded if the current into these pins is limited to less than 10mA.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +4.75V \text{ to } +5.5V \text{ for MAX703}, V_{CC} = +4.5V \text{ to } +5.5V \text{ for MAX704}, V_{BATT} = 2.8V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	COND	MIN	TYP	MAX	UNITS	
Operating Voltage Range VCC, VBATT		(Note 2)	0		5.5	V	
Supply Current (Excluding	louppuy	MAX70_C			200	350	
lout)	ISUPPLY	MAX70_E/M			200	500	μΑ
I <sub>SUPPLY</sub> in Battery-Backup		V <sub>CC</sub> = 0V, V <sub>BATT</sub> =	T <sub>A</sub> = +25°C		0.05	1.0	μΑ
Mode (Excluding I <sub>OUT</sub> )		2.8V	$T_A = T_{MIN}$ to $T_{MAX}$			5.0	μΑ
V <sub>BATT</sub> Standby Current		5.5V > V <sub>CC</sub> > V <sub>BATT</sub>	$T_A = +25^{\circ}C$	-0.10		+0.02	
(Note 3)		+ 0.2V	$T_A = T_{MIN}$ to $T_{MAX}$	-1.00		+0.02	μΑ
Very Output		I <sub>OUT</sub> = 5mA		V <sub>CC</sub> - 0.05	V <sub>CC</sub> - 0.025		V
V <sub>OUT</sub> Output		I <sub>OUT</sub> = 50mA	V <sub>CC</sub> - 0.5	V <sub>CC</sub> - 0.25		V	
V <sub>OUT</sub> in Battery-Backup Mode		I <sub>OUT</sub> = 250μA, V <sub>CC</sub> <	V <sub>BATT</sub> - 0.1	V <sub>BATT</sub> - 0.02		V	
Battery Switch Threshold		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	Power-up		20		m\/
(VCC - VBATT)		VCC < VRST	Power-down		-20		mV
Battery Switchover Hysteresis					40		mV
RESET Threshold	V <sub>RST</sub>	MAX703	MAX703		4.65	4.75	V
TLOET THICSHOID	*H51	MAX704	4.25	4.40	4.50	V	
RESET Threshold Hysteresis					40		mV
RESET Pulse Width	trst			140	200	280	ms
RESET Output Voltage	V <sub>OH</sub>	I <sub>SOURCE</sub> = 800µA		V <sub>CC</sub> - 1.5			
		ISINK = 3.2mA			0.4		
	V <sub>OL</sub>	MAX70_C, V <sub>CC</sub> = 1V, V <sub>BATT</sub> = 0V, I <sub>SINK</sub> = 5			0.3	V	
		MAX70_E/M, $V_{CC} = 1$ $V_{BATT} = 0V$ , $I_{SINK} = 1$			0.3		

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = +4.75V \text{ to } +5.5V \text{ for MAX703}, V_{CC} = +4.5V \text{ to } +5.5V \text{ for MAX704}, V_{BATT} = 2.8V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$ 

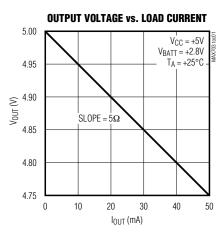
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
MD Input Throshold	VIL	Low			0.8	V
MR Input Threshold	VIH	High	2.0			V
MR Pulse Width	t <sub>MR</sub>		150			ns
MR to RESET Delay	t <sub>MD</sub>				250	ns
MR Pullup Current		$\overline{\text{MR}} = 0V$	100	250	600	μΑ
PFI Input Threshold		$V_{CC} = 5V$	1.20	1.25	1.30	V
PFI Input Current			-25	+0.01	+25	nA
PFO Output Voltage	VoH	ISOURCE = 800µA	V <sub>CC</sub> - 1.5			V
	VoL	I <sub>SINK</sub> = 3.2mA			0.4	

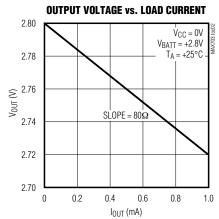
**Note 2:** Either V<sub>CC</sub> or V<sub>BATT</sub> can go to 0V if the other is greater than 2.0V.

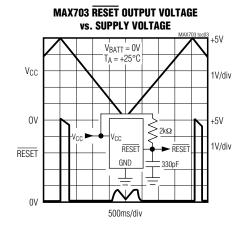
**Note 3:** "-" = battery-charging current, "+" = battery-discharging current.

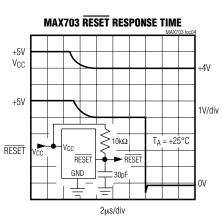
### **Typical Operating Characteristics**

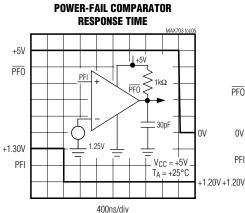
(VCC = +5V, VBATT = 2.8V, TA = +25°C, unless otherwise noted.)

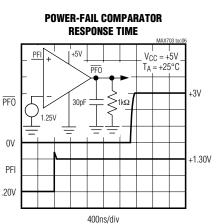












### **Pin Description**

PIN	NAME	FUNCTION
1	Vout	Supply Output for CMOS RAM. When $V_{CC}$ is above the reset threshold, $V_{OUT}$ connects to $V_{CC}$ through a p-channel MOSFET switch. When $V_{CC}$ is below the reset threshold, the higher of $V_{CC}$ or $V_{BATT}$ is connected to $V_{OUT}$ .
2	Vcc	+5V Supply Input
3	GND	Ground
4	PFI	Power-Fail Comparator Input. When PFI is less than 1.25V, PFO goes low; otherwise PFO remains high. Connect PFI to GND or VCC when not used.
5	PFO	Power-Fail Comparator Output. It goes low and sinks current when PFI is less than 1.25V; otherwise PFO remains high.
6	MR	Manual Reset Input. Generates a reset pulse when pulled below 0.8V. This active-low input is TTL/CMOS compatible and can be shorted to ground with a switch. It has an internal 250µA pullup current. Leave floating when not used.
7	RESET	Reset Output. Remains low while $V_{CC}$ is below the reset threshold (4.65V for the MAX703, 4.40V for the MAX704). It remains low for 200ms after $V_{CC}$ rises above the reset threshold (Figure 2) or $\overline{MR}$ goes from low to high.
8	V <sub>BATT</sub>	Backup-Battery Input. When $V_{CC}$ falls below the reset threshold, $V_{BATT}$ is switched to $V_{OUT}$ if $V_{BATT}$ is 20mV greater than $V_{CC}$ . When $V_{CC}$ rises 20mV above $V_{BATT}$ , $V_{CC}$ is switched to $V_{OUT}$ . The 40mV hysteresis prevents repeated switching if $V_{CC}$ falls slowly.

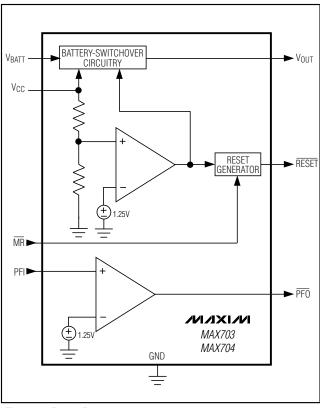


Figure 1. Block Diagram

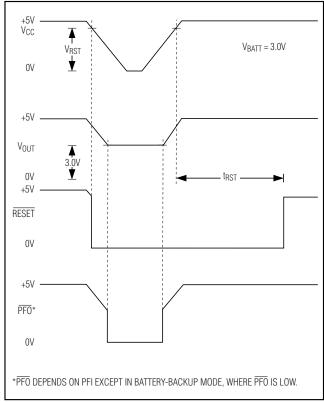


Figure 2. Timing Diagram

# Detailed Description RESET Output

A  $\mu P$ 's reset input starts the  $\mu P$  in a known state. Whenever the  $\mu P$  is in an unknown state, it should be held in reset. The MAX703/MAX704 assert reset when

held in reset. The MAX703/MAX704 assert reset when V<sub>CC</sub> is low, preventing code-execution errors during power-up, power-down, or brownout conditions.

When V<sub>BATT</sub> is 2V or more,  $\overline{\text{RESET}}$  is always valid, irrespective of V<sub>CC</sub>. On power-up, as V<sub>CC</sub> rises,  $\overline{\text{RESET}}$  remains low. When V<sub>CC</sub> exceeds the reset threshold, an internal timer holds  $\overline{\text{RESET}}$  low for a time equal to the reset pulse width (typically 200ms); after this interval,  $\overline{\text{RESET}}$  goes high (Figure 2). If a power-fail or brownout condition occurs (i.e., V<sub>CC</sub> drops below the reset threshold),  $\overline{\text{RESET}}$  is asserted. As long as V<sub>CC</sub> remains below the reset threshold, the internal timer is continually restarted, causing the  $\overline{\text{RESET}}$  output to remain low. Thus, a brownout condition that interrupts a previously initiated reset pulse causes an additional 200ms delay from the end of the last interruption.

### **Power-Fail Comparator**

The PFI input is compared to an internal reference. If PFI is less than 1.25V, PFO goes low. The power-fail comparator can be used as an undervoltage detector to signal a failing power supply. In the *Typical Operating Circuit*, an external voltage-divider at PFI is used to monitor the unregulated DC voltage from which the regulated +5V supply is derived.

The voltage-divider can be chosen so the voltage at PFI falls below 1.25V just before the +5V regulator drops out. PFO is then used as an interrupt to prepare the µP for power-down.

To conserve power, the power-fail comparator is turned off and  $\overline{PFO}$  is forced low when the MAX703/MAX704 enter battery-backup mode.

#### **Backup-Battery Switchover**

In the event of a brownout or power failure, it may be necessary to preserve the contents of RAM. With a backup battery installed at  $V_{BATT}$ , the MAX703/MAX704 automatically switch RAM to backup power when  $V_{CC}$  fails.

As long as V<sub>CC</sub> exceeds the reset threshold, V<sub>CC</sub> connects to V<sub>OUT</sub> through a 5 $\Omega$  p-channel MOSFET power switch. Once V<sub>CC</sub> falls below the reset threshold, RESET goes low and V<sub>CC</sub> or V<sub>BATT</sub> (whichever is higher) switches to V<sub>OUT</sub>. Note that V<sub>BATT</sub> switches to V<sub>OUT</sub> through an 80 $\Omega$  switch) only if V<sub>CC</sub> is below the reset-threshold voltage **and** V<sub>BATT</sub> is greater than V<sub>CC</sub>. When V<sub>CC</sub> exceeds the reset threshold, it is connected to the MAX703/MAX704 substrate, regardless of the voltage

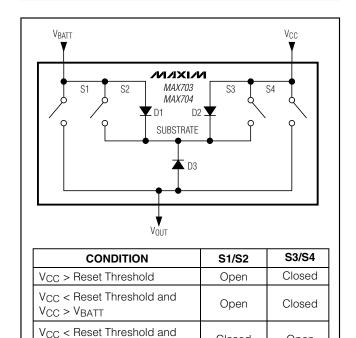
applied to V<sub>BATT</sub> (Figure 3). During this time, diode D1 (between V<sub>BATT</sub> and the substrate) conducts current from V<sub>BATT</sub> to V<sub>CC</sub> if V<sub>BATT</sub>  $\geq$  (V<sub>CC</sub> + 0.6V).

When the battery-backup mode is activated, VBATT connects to VOUT. In this mode, the substrate connects to VBATT and internal circuitry is powered from the battery (Figure 3). Table 1 shows the status of the MAX703/MAX704 inputs and outputs in battery-backup mode.

When VCC is below, but within, 1V of VBATT, the internal switchover comparator draws about 30µA. Once VCC

# Table 1. Input and Output Status in Battery-Backup Mode

SIGNAL	STATUS
Vcc	Disconnected from V <sub>OUT</sub> .
Vout	Connected to VBATT through an internal $80\Omega$ p-channel MOSFET switch.
VBATT	Connected to $V_{OUT}$ . Supply current is < 1 $\mu$ A when $V_{CC}$ < ( $V_{BATT}$ - 1 $V$ ).
RESET	Logic-low.
PFI	Power-fail comparator is disabled.
PFO	Logic-low.
MR	Disabled.



Closed

Figure 3. Battery-Switchover Block Diagram

VCC < VBATT

Open

drops to more than 1V below VBATT, the internal switchover comparator shuts off and the supply current falls to less than 1µA.

#### **Manual Reset**

The manual reset input  $(\overline{MR})$  allows  $\overline{RESET}$  to be activated by a pushbutton switch. The switch is effectively debounced by the 140ms minimum reset pulse width. Because it is TTL/CMOS compatible,  $\overline{MR}$  can be driven by an external logic line.

### **Applications Information**

# Using a SuperCap® as a Backup Power Source

SuperCaps are capacitors with extremely high capacitance values (on the order of 0.1 Farad). When using SuperCaps, if  $V_{CC}$  exceeds the MAX703/MAX704 reset thresholds (4.65V and 4.40V, respectively),  $V_{BATT}$  may not exceed  $V_{CC}$  by more than 0.6V. Thus, with a 5% tolerance on  $V_{CC}$ ,  $V_{BATT}$  should not exceed  $V_{CC}$  (min) + 0.6V = 5.35V. Similarly, with a 10% tolerance on  $V_{CC}$ ,  $V_{BATT}$  should not exceed 5.1V.

Figure 4's SuperCap circuit uses the MAX703 with a  $\pm 5\%$  tolerance voltage supply. In this circuit, the SuperCap rapidly charges to within a diode drop of V<sub>CC</sub>. However, the diode leakage current with trickle-charge the SuperCap voltage to V<sub>CC</sub>. If V<sub>BATT</sub> = 5.25V and the power is suddenly removed and then reapplied with V<sub>CC</sub> = 4.75V, V<sub>BATT</sub> - V<sub>CC</sub> does not exceed the allowable 0.6V difference voltage.

Figure 5's circuit uses the MAX704 with a  $\pm 10\%$  tolerance voltage supply. Note that if  $V_{CC} = 5.5V$  and  $V_{BATT} \leq 5.1V$ , the power can be suddenly removed and reapplied with  $V_{CC} = 4.5V$ , and  $V_{BATT} - V_{CC}$  will not exceed the allowable 0.6V voltage difference.

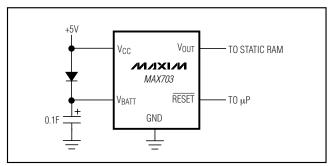


Figure 4. Using a SuperCap as a Backup Power Source with a MAX703 and a  $+5V \pm 5\%$  Supply

SuperCap is a registered trademark of Bankor Industries.

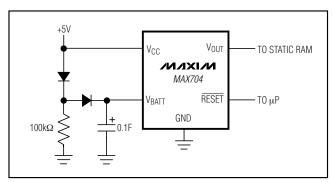


Figure 5. Using a SuperCap as a Backup Power Source with the MAX704 and a +5V ±10% Supply

### **Batteries and Power Supplies as Backup Power Sources**

Lithium batteries work well as backup batteries because they have very low self-discharge rates and high-energy density. Single lithium batteries with opencircuit voltages of 3.0V to 3.6V are ideal for use with the MAX703/MAX704. Batteries with an open-circuit voltage less than the minimum reset threshold plus 0.3V can be directly connected to the MAX703/MAX704 VBATT input with no additional circuitry (see the *Typical Operating Circuit*).

However, batteries with open-circuit voltages greater than the reset threshold plus 0.3V CANNOT be used as backup batteries, since they source current into the substrate through diode D1 (Figure 3) when V<sub>CC</sub> is close to the reset threshold.

PART	MAXIMUM BACKUP-BATTERY VOLTAGE (V)
MAX703	4.80
MAX704	4.55

## Using the MAX703/MAX704 without a Backup Power Source

If a backup power source is not used, ground VBATT and connect VCC to VOUT. A direct connection to VCC eliminates any voltage drop across the internal switch, which would otherwise appear at VOUT. Alternatively, use the MAX705–MAX708, which do not have battery-backup capabilities.

### Ensuring a Valid RESET Output Down to V<sub>CC</sub> = 0V

When VCC falls below 1V, the MAX703/MAX704 RESET output no longer sinks current; it becomes an open circuit. High-impedance CMOS logic inputs can drift to undetermined voltages if left as open circuits. If a pull-down resistor is added to the RESET pin as shown in Figure 6, any stray charge or leakage currents will flow to ground, holding RESET low. Resistor value R1 is not critical. It should be about  $100k\Omega$ , which is large enough not to load RESET and small enough to pull RESET to ground.

### Replacing the Backup Battery

The backup battery can be removed while V<sub>CC</sub> remains valid without triggering a reset. As long as V<sub>CC</sub> stays above the reset threshold, battery-backup mode cannot

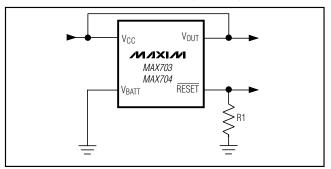


Figure 6. RESET Valid to Ground Circuit

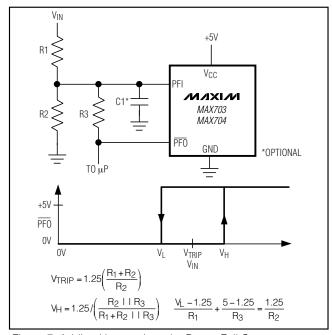


Figure 7. Adding Hysteresis to the Power-Fail Comparator

be entered. This is an improvement on switchover ICs that initiate a reset when  $V_{\rm CC}$  and  $V_{\rm BATT}$  are at or near the same voltage level (regardless of the reset threshold voltage). If the voltage on the unconnected  $V_{\rm BATT}$  pin floats up toward  $V_{\rm CC}$ , this condition alone cannot initiate a reset when using the MAX703/MAX704.

### Adding Hysteresis to the Power-Fail Comparator

Hysteresis adds a noise margin to the power-fail comparator and prevents repeated triggering of  $\overline{PFO}$  when  $V_{IN}$  is near the power-fail comparator trip point. Figure 7 shows how to add hysteresis to the power-fail comparator. Select the ratio of R1 and R2 so that PFI sees 1.25V when  $V_{IN}$  falls to the desired trip point (VTRIP). Resistor R3 adds hysteresis. It will typically be an order of magnitude greater than R1 or R2. The current through R1 and R2 should be at least 1µA to ensure that the 25nA (max) PFI input current does not shift the trip point. R3 should be larger than  $10k\Omega$  to prevent it from loading down the  $\overline{PFO}$  pin. Capacitor C1 adds additional noise rejection.

### **Monitoring a Negative Voltage**

The power-fail comparator can be used to monitor a negative supply voltage using Figure 8's circuit. When the negative supply is valid, PFO is low. When the negative supply voltage droops, PFO goes high. This circuit's accuracy is affected by the PFI threshold tolerance, the VCC voltage, and resistors R1 and R2.

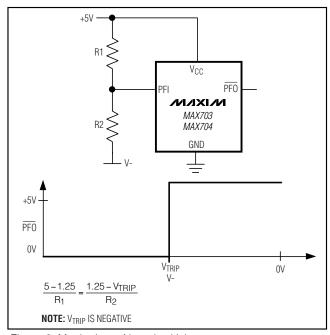


Figure 8. Monitoring a Negative Voltage

# Using the Power-Fail Comparator to Assert Reset

In addition to asserting reset at the V<sub>CC</sub> reset threshold voltage, reset can also be asserted at the PFI input threshold voltage. Connect PFO to MR to initiate a reset

pulse when the monitored supply drops below a userspecified threshold or when V<sub>CC</sub> falls below the reset threshold. For additional noise rejection, place a capacitor between PFI and GND.

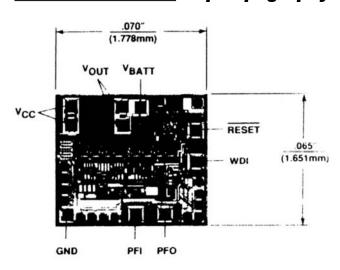
**Table 3. Maxim Microprocessor Supervisory Products** 

PART	NOMINAL RESET THRESHOLD (V)	MINIMUM RESET PULSE WIDTH (ms)	NOMINAL WATCH- DOG TIMEOUT PERIOD (s)	BACKUP- BATTERY SWITCH	CE WRITE PROTECT	POWER-FAIL COMPARATOR	MANUAL RESET INPUT	WATCH- DOG INPUT	LOW- LINE OUTPUT	ACTIVE- HIGH RESET	BATT ON OUTPUT
MAX690A	4.65	140	1.6	Yes	No	Yes	No	No	No	No	No
MAX691A	4.65	140/Adj.	1.6/Adj.	Yes	Yes	Yes	No	Yes	Yes	Yes	Yes
MAX692A	4.40	140	1.6	Yes	No	Yes	No	No	No	No	No
MAX693A	4.40	140/Adj.	1.6/Adj.	Yes	Yes	Yes	No	Yes	Yes	Yes	Yes
MAX696	Adj.	35/Adj.	1.6/Adj.	Yes	No	Yes	No	Yes	Yes	Yes	Yes
MAX697	Adj.	35/Adj.	1.6/Adj.	No	Yes	Yes	No	Yes	Yes	Yes	No
MAX700	4.65/Adj.	200	_	No	No	No	Yes	No	No	Yes	No
MAX703	4.65	140	_	Yes	No	Yes	Yes	No	No	No	No
MAX704	4.40	140	_	Yes	No	Yes	Yes	No	No	No	No
MAX705	4.65	140	1.6	No	No	Yes	Yes	Yes	No	No	No
MAX706	4.40	140	1.6	No	No	Yes	Yes	Yes	No	No	No
MAX707	4.65	140	_	No	No	Yes	Yes	No	No	Yes	No
MAX708	4.40	140	_	No	No	Yes	Yes	No	No	Yes	No
MAX791	4.65	140	1.0	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
MAX1232	4.50/4.75	250	0.15/0.60/ 1.2	No	No	No	Yes	No	No	Yes	No
MAX1259	_	_	_	Yes	No	Yes	No	No	No	No	No

### Chip Topography

Package Information

For the latest package outline information, go to **www.maxim-ic.com/packages**.



SUBSTRATE MUST BE LEFT UNCONNECTED TRANSISTOR COUNT: 573

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